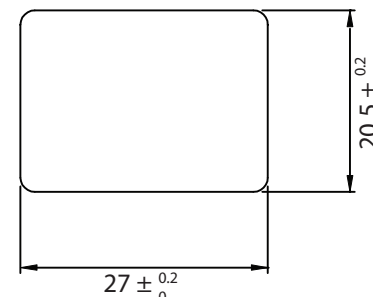
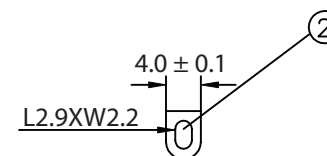
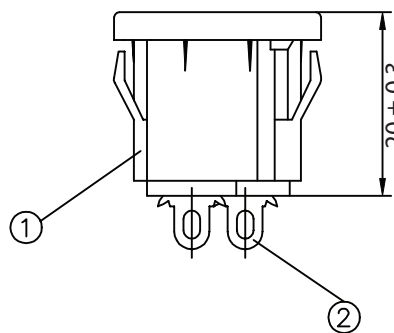
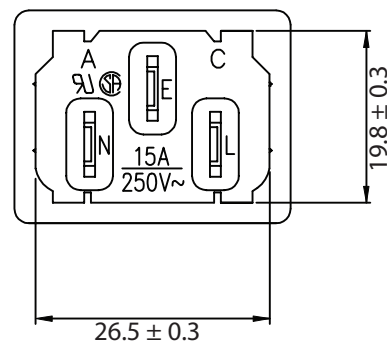
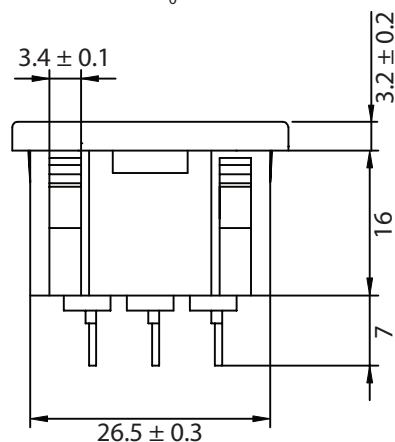
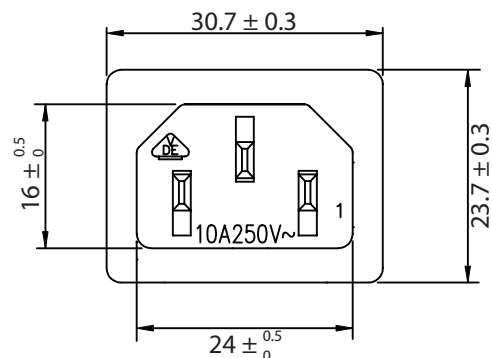


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REVISION			
REV.	DESCRIPTION	DATE	APPROVED
B	RoHS Compliancy	06-01-06	DP
C	Updated Dimensions	06-30-08	DP



PANEL CUTOUT THICKNESS FOR PLASTIC PANEL 0.8mm~1.5mm
PANEL CUTOUT THICKNESS FOR STEEL PANEL 0.8mm~2.0mm

NOTES:

MATERIAL:

HOUSING: THERMOPLASTIC

TERMINAL: COPPER ALLOY

RATING:

UL, CSA: 15A 250V AC

VDE: 10A 250V AC

INSULATION RESISTANCE: OVER 100M OHM 500V DC

DIELECTRIC RESISTANCE: 2000V AC ONE MINUTE

APPROVALS: UL, CSA, VDE

RoHS COMPLIANT

CONTROLLED

2	Terminal Set COPPER ALLOY Tin-Plated	3
1	Housing SNAP-IN TYPE	1
Dim range (mm) Tolerance +/- (mm) Qualtek Electronics Corp. PPC DIVISION Part Number: 701W-X2/02 RoHS Compliant		
0-1	0.15	Description: AC RECEPTACLE
1-6	0.20	
6-18	0.30	UNIT: mm
18-50	0.50	
50-120	0.70	REV. C
120-250	0.90	
250-500	1.20	Drawn / Date Checked / Date Approved / Date
		B.Zhang 10-25-04 10-25-04 JJH / 10-25-04